<table>
<thead>
<tr>
<th>PART NUMBER(S):</th>
<th>Please see attachment.</th>
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</thead>
<tbody>
<tr>
<td>PCN No.:</td>
<td>06-0130-29a</td>
</tr>
<tr>
<td>DATE:</td>
<td>June 23, 2006</td>
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</tbody>
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**PART DESCRIPTION:**

Power Management and Interface Products – Change in Wafer Fabrication Site

**LEVEL OF CHANGE:**

- [X] Level I, Customer Approval.
- [ ] Level II, Customer Information.

**PRODUCT ATTRIBUTE AFFECTED:**

- [ ] Material Change
- [ ] Design Change
- [X] Process Change
- [X] Other, Explain: Wafer Fabrication Site Transfer

**DESCRIPTION OF CHANGE:**

Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry EPISIL. See attached Product List no. 29a.

**REASON FOR CHANGE:**

Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.

**FABRICATION PROCESS QUALIFICATION COMPLETED (DATE):** August 7, 2006

**PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE):** August 14, 2006

* Samples representative of product from the Product Family being transferred.
PRODUCT CHANGE NOTICE

EARLIEST DATE OF PRODUCTION
SHIPMENTS: October 31, 2006

EFFECTIVITY CHANGE DATE OR DATE CODE: Work week associated with earliest production shipment.

[ ] STANDARD DISTRIBUTION  [ X ] CUSTOM DISTRIBUTION

PERSON TO CONTACT WITH QUESTIONS:

Fred Claussen
VP Quality Assurance and Reliability
Sipex Corporation
Phone Number: 408-935-7644
FAX NUMBER: 408-935-7678
PCN No.: 06-0130-29a

List 29a

SP526CF
SP526CF-L